

## General Description

The SDC6073 is a One-cell lithium-Ion (Li-Ion) and lithium-polymer (Li-Pol) battery protection IC that integrated an on-chip FET switch thus reducing manufacturing costs and increasing reliability. The device is designed to protect both Li-Ion and Li-Pol battery packs from either overcharge, overdischarge, or over-current.

The device contains all required protection control circuits together with a very low resistive FET switch to minimize the number of external components.

## Features

- Internal MOSFET, and reduce costs.
- Only two external capacitor required in the application.
- Over Temperature Protection.
- Charger Detection Function.
- Internal high accuracy voltage detection circuit.
- Internal high accuracy current detection circuit.
- Short-circuit protection.
- 0V charging function.
- Delay times are generated by an internal circuit, and no external capacitor is required.
- Overcharge current protection.

## Applications

- Li-Ion Rechargeable Battery Packs
- Li-Pol Rechargeable Battery Packs



Figure 1. Package Type

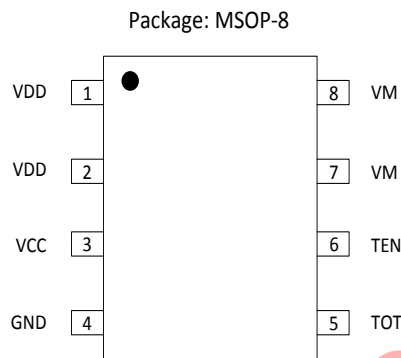
**Pin Configuration**


Figure 2. Pin Configuration

Pin Number	Pin Name	Function
1	VDD	Positive power input
2	VDD	Positive power input
3	VCC	Core circuit power supply pin
4	GND	Ground pin
5	TOT	Test mode output, connect to GND in normal operation
6	TEN	Test mode enable, connect to GND in normal operation
7	VM	Positive charge input, overcurrent detection
8	VM	Positive charge input, overcurrent detection

Table 1. Pin Description

**Product Series**

Model	Package	Overcharge Detection Vol.[V <sub>CU</sub> ](V)	Overcharge Hysteresis Vol.[V <sub>HC</sub> ](V)	Overdischarge Detection Vol. [V <sub>DL</sub> ](V)	Overdischarge Hysteresis Vol. [V <sub>HD</sub> ](V)	Overcurrent 1 Detection Cur. [I <sub>OC1</sub> ](A)	0V Bat. Charge Enable	Recovery
SDC6073AA	MSOP-8	4.30±0.05	0.175±0.025	2.50±0.05	0.40±0.05	3.0±0.9	yes	yes

Table 2. Product Series

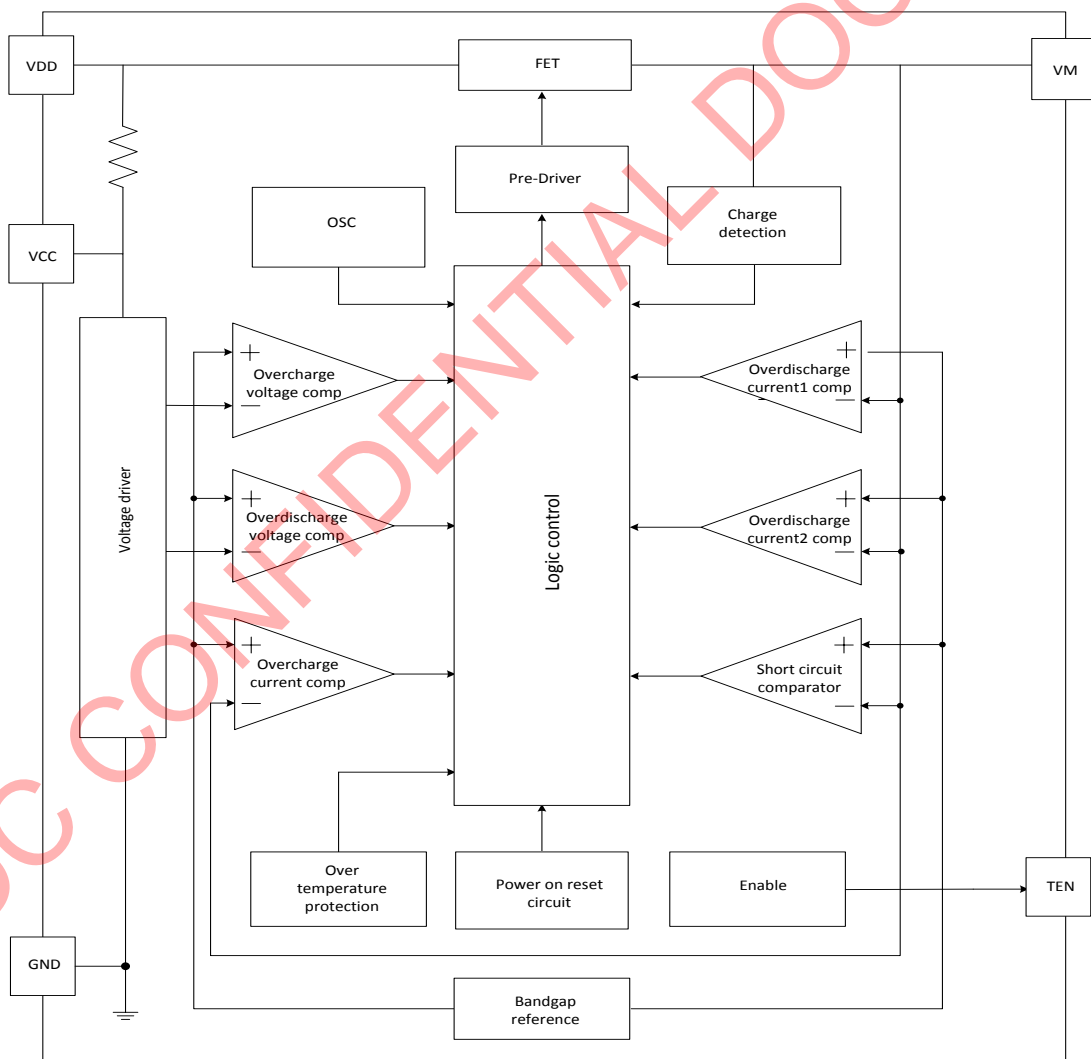
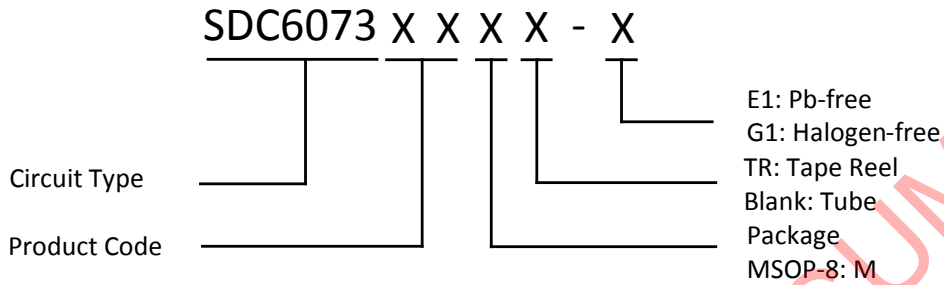
**Functional Block Diagram**


Figure 3. Functional Block Diagram

**Ordering Information**


Package	Temperature	Part Number		Marking ID		Packing Type
		Pb-free	Halogen-free	Pb-free	Halogen-free	
MSOP-8	-40°C~85°C	SDC6073AAMTR-E1	SDC6073AAMTR-G1	6073AA	6073AAG	Tape Reel
		SDC6073AAM-E1	SDC6073AAM-G1	6073AA	6073AAG	Tube

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**Absolute Maximum Ratings** (NOTE: Stresses greater than those listed under Absolute Maximum Ratings may cause permanent damage to the device.)

Parameter	Symbol	Value	Unit
Supply Voltage (between VDD and GND)	$V_{DD}$	-8.0~8.0	V
Charger Input Voltage (between VM and GND)	$V_{MAX}$	-10.0~10.0	V
ESD, HBM model per Mil-Std-883, Method 3015	HBM	2000	V
ESD, MM model per JEDEC EIA/JESD22-A115	MM	200	V
Latch-up test per JEDEC 78	-	200	mA
Storage Temperature Range	$T_{STG}$	-55~125	°C
Power Dissipation	$P_{MAX}$	500	mW

Table 3. Absolute Maximum Ratings

Note: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device.

### Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit
Supply voltage (between VDD and GND)	$V_{DD}$	2.0	4.5	V
Charger input voltage (between VM and GND)	$V_{MAX}$	4.5	5.5	V
Operating Temperature Range	$T_{OPR}$	0	45	°C

Table 4. Recommended Operating Conditions

**Electrical Characteristics** (Ta=25°C, unless otherwise specified)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Detection Voltage</b>						
Overcharge Detection Voltage	V <sub>CU</sub>	-	4.25	4.30	4.35	V
Overcharge Hysteresis Voltage	V <sub>HC</sub>	-	0.15	0.175	0.20	V
Overdischarge Detection Voltage	V <sub>DL</sub>	-	2.45	2.5	2.55	V
Overdischarge Hysteresis Voltage	V <sub>HD</sub>	-	0.35	0.4	0.45	V
Charger Detection Voltage	V <sub>CHG</sub>	-	V <sub>DD</sub> +0.1	V <sub>DD</sub> +0.15	V <sub>DD</sub> +0.2	V
<b>Detection Current</b>						
Overcharge Current Detection Current	I <sub>COC</sub>	V <sub>DD</sub> =3.5V	2.1	3.0	3.9	A
Overdischarge Current 1 Detection Current	I <sub>OC1</sub>	V <sub>DD</sub> =3.5V	2.1	3.0	3.9	A
Overdischarge Current 2 Detection Current	I <sub>OC2</sub>	V <sub>DD</sub> =3.5V	4.5	6.0	7.0	A
Load Short-circuiting Detection Voltage	V <sub>SIP</sub>	V <sub>DD</sub> =3.5V	1.2	1.25	1.3	V
<b>Current Consumption</b>						
Current Consumption in Normal Operation	I <sub>OPEN</sub>	V <sub>DD</sub> =3.5V, VM pin floating	1.0	1.5	3.0	uA
Current Consumption in Power Down	I <sub>PD</sub>	V <sub>DD</sub> =1.5V, VM pin floating	-	-	0.23	uA
<b>VM Internal Resistance</b>						
Internal Resistance between VM and VDD	R <sub>VMD</sub>	V <sub>DD</sub> =3.5V,VM=1.0V	13	20	30	kΩ
Internal Resistance between VM and GND	R <sub>VMS</sub>	V <sub>DD</sub> =2.0V,VM=1.0V	300	450	675	kΩ
<b>FET on Resistance</b>						
Equivalent FET on Resistance	R <sub>ON</sub>	V <sub>DD</sub> =4V,I <sub>VM</sub> =1A	-	29	-	mΩ
<b>Over Temperature Protection</b>						
Over Temperature Protection	T <sub>SHD+</sub>	-	-	100	-	°C
<b>Detection Delay Time</b>						
Overcharge Voltage Detection Delay Time	t <sub>CU</sub>	-	1.3	1.5	1.7	S
Overdischarge Voltage Detection Delay Time	t <sub>DL</sub>	-	145	180	210	mS
Overdischarge Current 1 Detection Delay Time	t <sub>OC1</sub>	V <sub>DD</sub> =3.5V	9.0	11	13.5	mS
Overdischarge Current 2 Detection Delay Time	t <sub>OC2</sub>	V <sub>DD</sub> =3.5V	4.48	5.38	6.45	mS
Load Short-Circuit Detection Delay Time	t <sub>SIP</sub>	V <sub>DD</sub> =3.5V	300	450	600	uS
Overcharge Current Detection Delay Time	t <sub>COC</sub>	V <sub>DD</sub> =3.5V	9.0	11	13.5	mS

Table 5. Electrical Characteristics

## Function Description

### Normal Condition

If  $V_{DL} < V_{CC} < V_{CU}$  &  $V_{COC} < V_{CS} < V_{OC1}$ , CO and DO are both high, the charging and discharging processes can be operated normally.

The SDC6073 is a one-cell lithium-Ion (Li-Ion) and lithium-polymer (Li-Pol) battery protection IC. Battery charge/discharge state is continuously monitored for fault conditions. In the event of an over-voltage, short-circuit, over-current or over-temperature failure, the device will automatically shut down through internal power switch, thus protecting the charging device, control system, and the battery.

### Normal operating mode

If no exception condition is detected, charging and discharging can be carried out freely. This condition is called the normal operating mode.

### Overcharge voltage condition

When the battery voltage becomes higher than the overcharge detection voltage ( $V_{CU}$ ) and continues for a period equal to overcharge voltage detection delay time ( $t_{CU}$ ) or longer, the SDC6073 will control internal MOSFET to stop charging.

The overcharge condition is released in the following two cases.

- (1). Charger is connected, battery voltage falls below overcharge release voltage  $V_{CL}$  ( $V_{CL} = V_{CU} - V_{HC}$ ).
- (2). Charger is disconnected and battery voltage falls below overcharge detection voltage  $V_{CU}$ .

If charger is disconnected and battery voltage is still higher than  $V_{CU}$ , battery will discharge through internal diode until battery voltage falls below  $V_{CU}$ .

### Overcharge current condition

Under the charge condition, if current exceeds overcharge current  $I_{COC}$  and continues for overcharge current detection delay time  $t_{COC}$  or longer, The IC will control internal MOSFET to stop charging.

Release condition:

The SDC6073 will release the overcharge current condition as soon as the charge current is below  $I_{COC}$ .

### Overdischarge voltage condition

When battery voltage falls below overcharge detection voltage  $V_{DL}$  and continues for overdischarge detection delay time  $t_{DL}$  or longer, the SDC6073 will disconnect battery from load to stop further discharging. The situation is called overdischarge voltage condition.

When battery voltage is 1.5V (Typical) or lower, current consumption is reduced to power-down current consumption IPD. This situation is called power-down condition.

Release condition:

- (1). The power-down condition is released when a charger is connected and voltage difference between pin VM and GND becomes 2.0V (Typical) or higher. Moreover when battery voltage becomes overdischarge detection voltage  $V_{DL} + V_{HD}$  or higher, the SDC6073 returns to the normal condition.
- (2). The overdischarge condition is released when a charger is connected and voltage difference between pin VM and GND becomes  $V_{DL} + V_{HD}$  or higher, the SDC6073 returns to the normal.

### Overdischarge Current Condition (Detection of Overdischarge current1, Overdischarge current 2)

Under normal condition, if discharge current exceeds Overdischarge current 1  $I_{OC1}$  or Overdischarge current 2

$I_{OC2}$ , and lasts for a period of overdischarge current1 delay time ( $t_{OC1}$ ) or overdischarge current2 delay time ( $t_{OC2}$ ) separately, battery will be disconnected from load.

Release condition:

The overdischarge current status is reset when impedance between VM pin and GND is larger than 500k $\Omega$ .

### Charger reverse connect protection

If a charger is reversely connected, the SDC6073 will cut off the reverse charging current through the charger.

Release condition:

When the charger is disconnect, the SDC6073 returns to the normal condition.

### Load Short-circuit condition

If voltage of VM pin is equal or below short circuit protection voltage  $V_{SIP}$ , the IC will stop discharging and the battery is disconnected from load. The maximum

delay time to switch current off is  $t_{SIP}$ .

Release condition:

This status is released when voltage of VM pin is higher than  $V_{SIP}$ , such as disconnecting load.

### Charger Detection

When a battery in overdischarge condition is connected to a charger and provided that voltage of VM pin is equal or higher than charger detection voltage  $V_{CHG}$ , the SDC6073 releases overdischarge condition when battery voltage becomes equal to  $V_{DL}$ .

When a battery in overdischarge condition is connected to a charger and provided that voltage of VM pin is equal or higher than 2.0V (Typical), and lower than charger detection voltage  $V_{CHA}$ , the SDC6073 releases overdischarge condition when battery voltage reaches overdischarge detection voltage  $V_{DL}+V_{HD}$ .



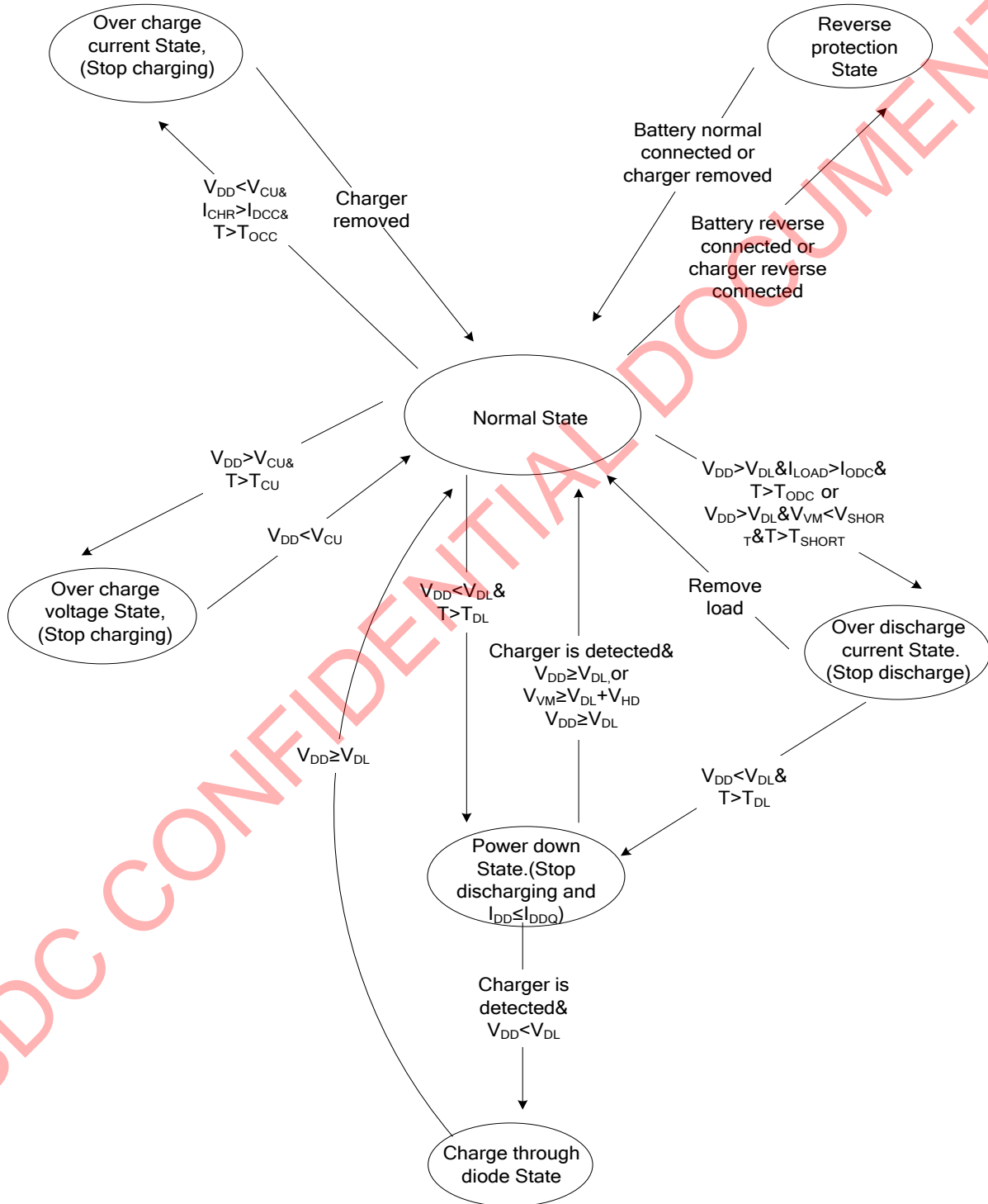
**Operation State Diagram**


Figure 4. Operation State Diagram

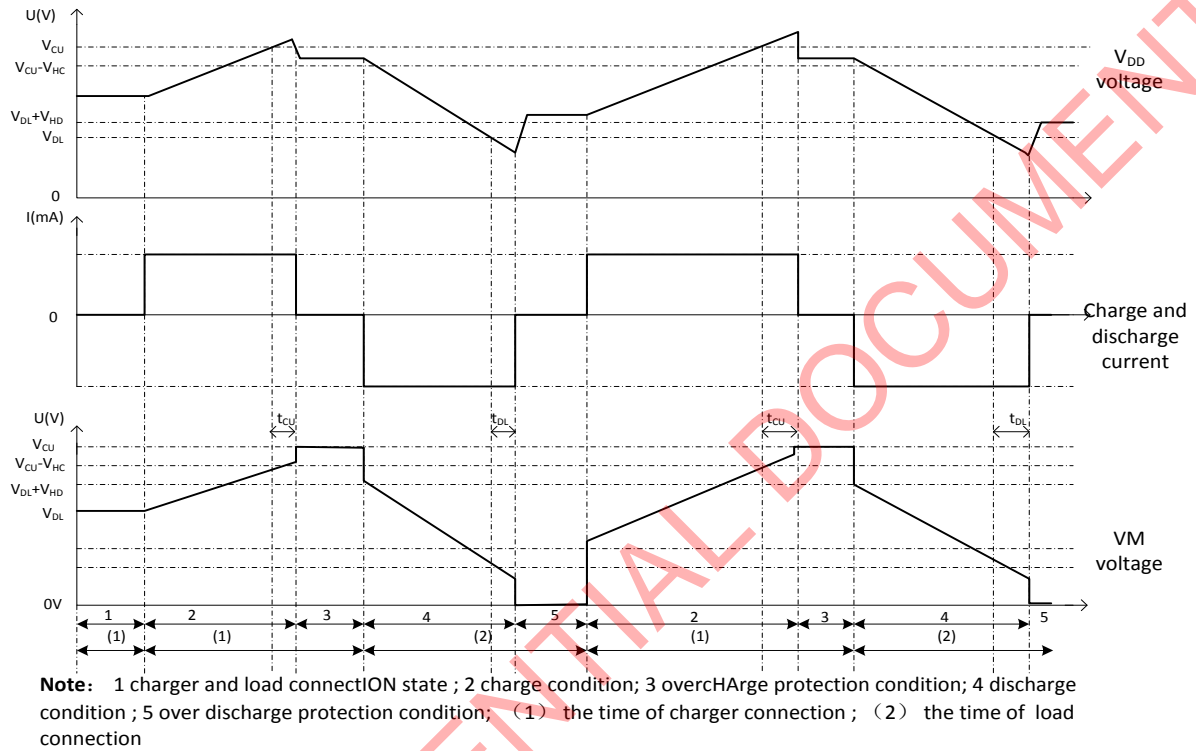
**Operation Timing Chart**


Figure 5. Charge and Discharge circle timing diagram

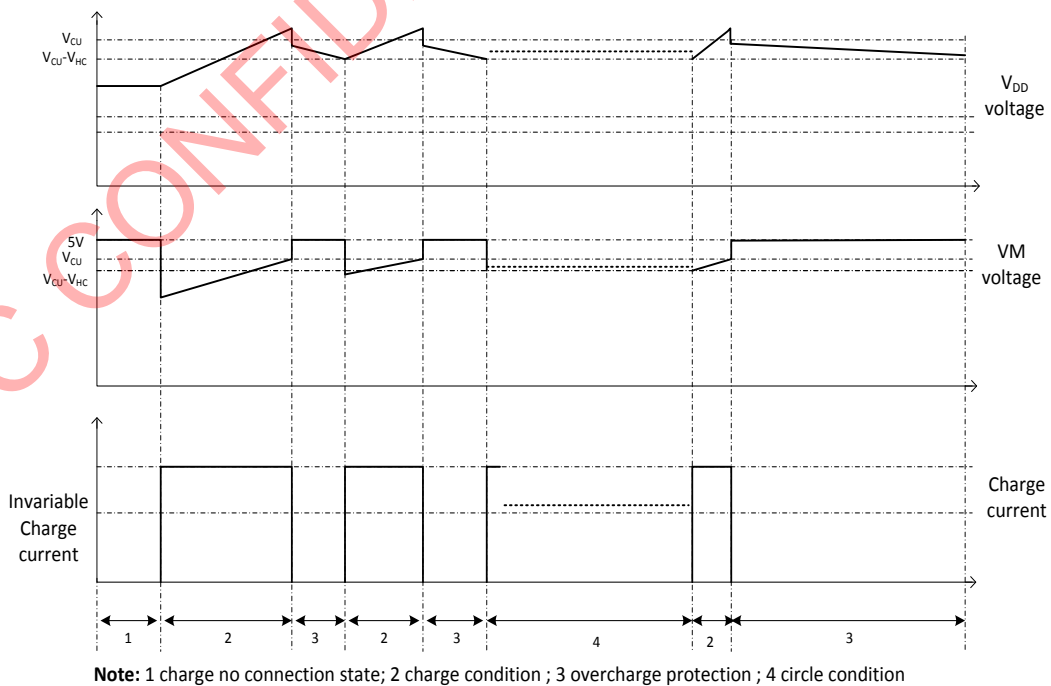
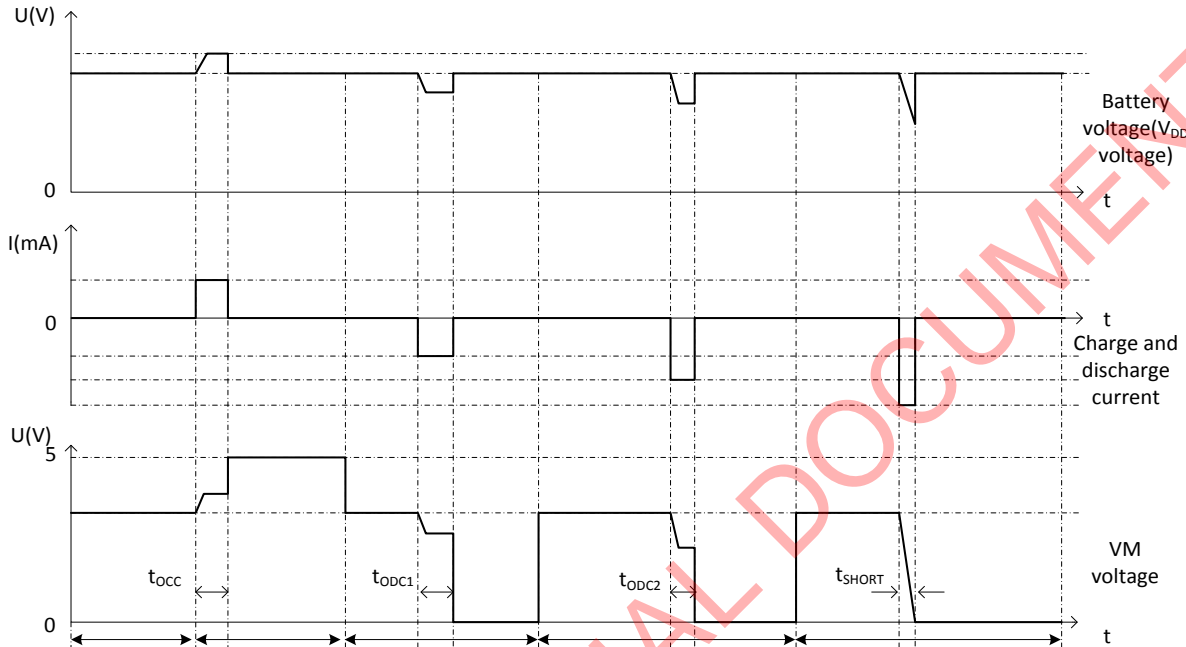
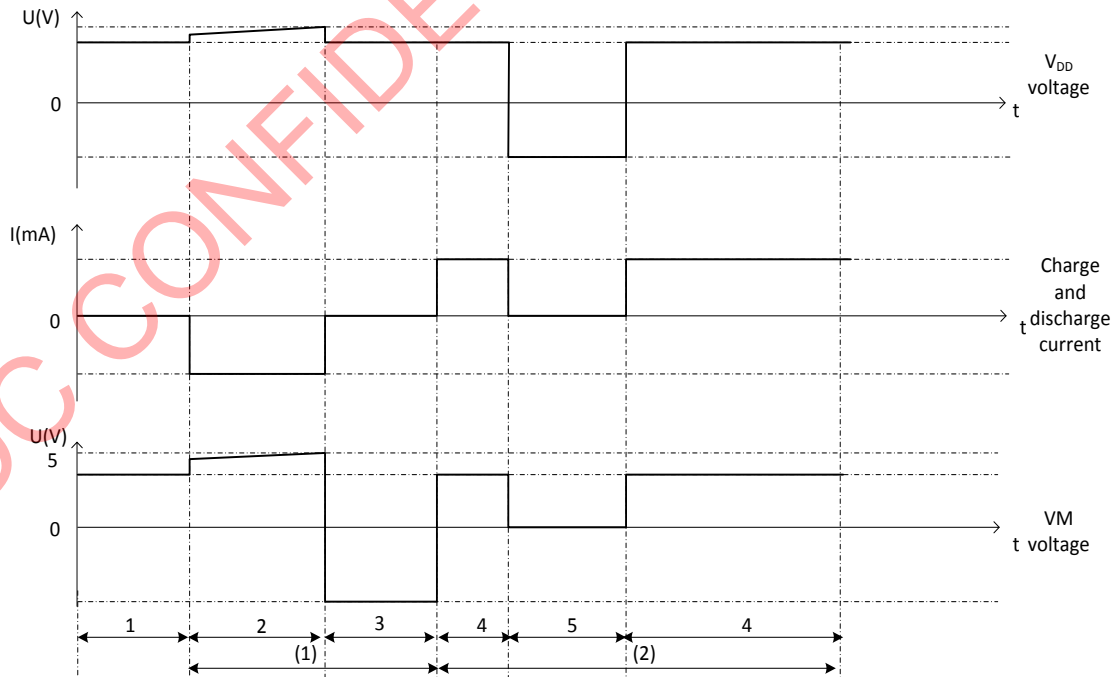


Figure 6. Overcharge protection circle timing diagram



**Note:** 1 charger and load no connection; 2 overcharge current state; 3 over discharge current 1 state; 4 over discharge current 2 state; 5 short-circuit state;

Figure 7. Overcurrent and short-circuit protection state timing diagram



**Note:** 1 charger and load no connection state ; 2 normally charge; 3 charger reverse connected state ; 4 normally discharge state; 5 Battery reverse connected state ; (1) the time of charge connection ; (2) the time of load connection

Figure 8. Reverse connected protection state timing diagram

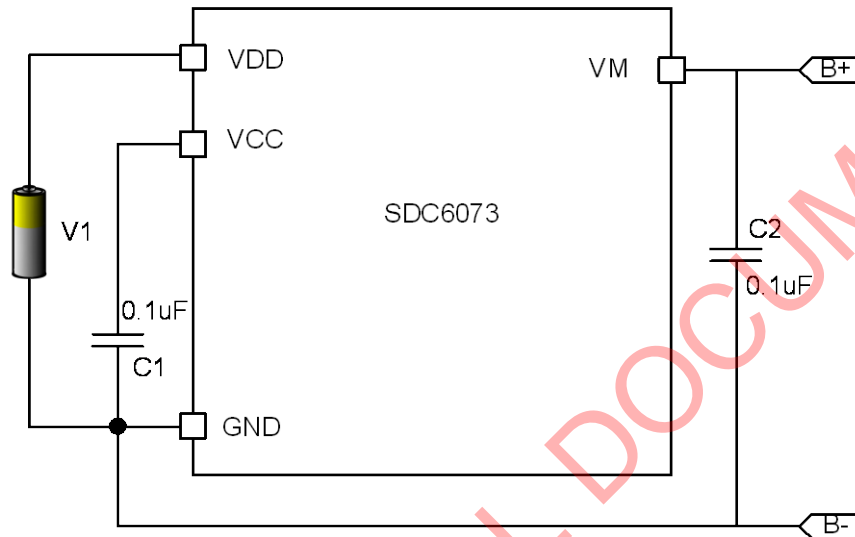
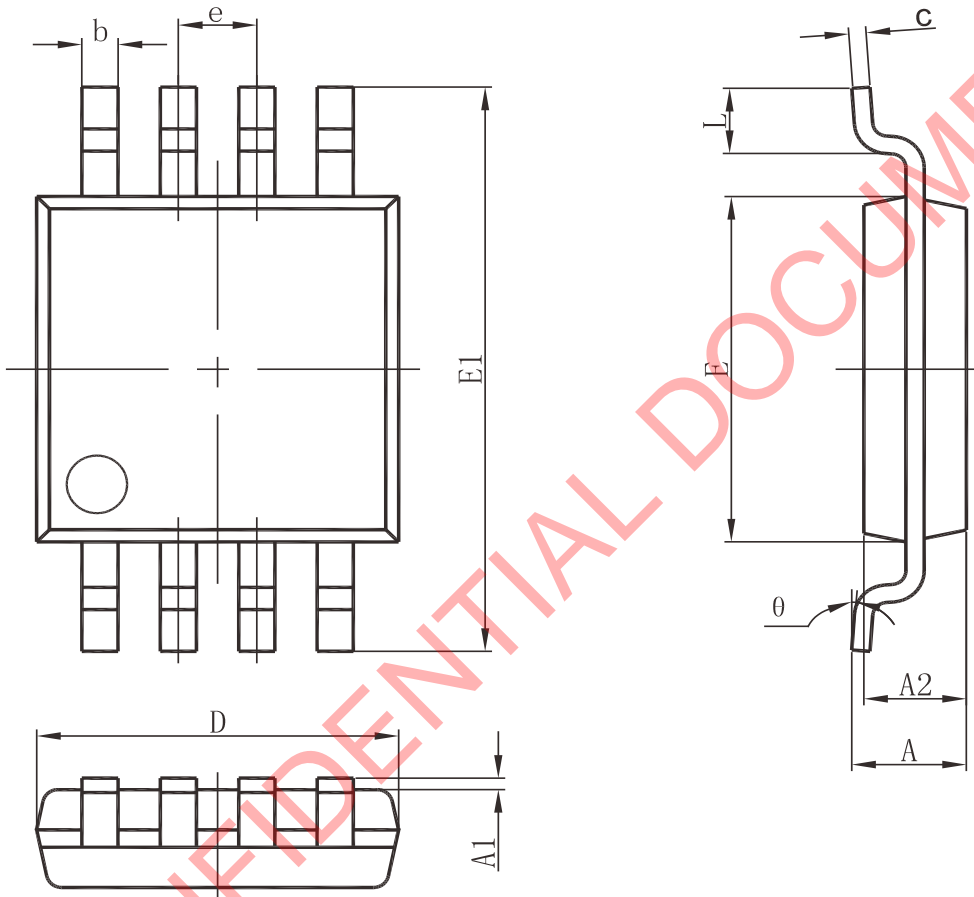
**Typical Application**


Figure 9. Typical Application

**Note:**

1. C1 is used for protecting power fluctuation. Recommend Value is 0.1uF, minimum value 0.022uF, and maximum value 1.0uF.
2. The above typical application can not guarantee all cases. Please adjust the value of C1 and C2 according to actual application.

**Package Dimension**  
**MSOP-8**


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.820	1.100	0.032	0.043
A1	0.020	0.150	0.001	0.006
A2	0.750	0.950	0.030	0.037
b	0.250	0.380	0.010	0.015
c	0.090	0.230	0.004	0.009
D	2.900	3.100	0.114	0.122
e	0.650(BSC)		0.026(BSC)	
E1	4.750	5.050	0.187	0.199
E	2.900	3.100	0.114	0.122
L	0.400	0.800	0.016	0.031
θ	0°	6°	0°	6°



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